



**APPLICATION FOR EXTENSION OF ESCC QUALIFICATION APPROVAL**

Component Title: DIODES, MICROWAVE, SILICON, SCHOTTKY, GENERAL PURPOSE, BASED ON TYPES BAS40-xx, BAS70-xx, BXY42-xx, BXY43-xx, BXY44-xx  
 Executive Member: German Space Agency at DLR Date: 19/10/2023

Page 1  
 Appl. No. 227K

Components (including series and families) submitted for Extension of Qualification Approval:

ESCC COMPONENT NO.	VARIANTS	RANGE OF COMPONENTS	BASED ON	TEST VEHICLE / S	COMPONENT SIMILAR
5512/020 5513/017 5513/030	01, 03, 04, 05 01, 02, 03 01, 02, 05, 06, 09, 10		BAS70-xx, BAS40-xx; BXY42-xx; BXY43-xx, BXY44-xx	BAS70-T1(ES)	X

Component Manufacturer Infineon Technologies AG	Location of Manufacturing Plant(s) Villach, Austria and Regensburg, Germany for Silicon Neubiberg, Germany for packing and screening	Date of original qualification approval: Date: 1996  Certificate Ref No. 227, initial: Sept. 1996
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ESCC Specifications used for Maintenance of qualification testing: Generic: 5010 Issue: 3 Detail(s): 5513/020 Issue: 6	Deviations to LVT testing and Detail Specification used: No <input checked="" type="checkbox"/> Yes <input type="checkbox"/> (supply details in Box 15)  Deviation from current Specifications: No <input checked="" type="checkbox"/> Yes <input type="checkbox"/> (Supply details)	Qualification Extension Report reference and date: 2236LR40, Iss. 1, Aug. 2023
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Summary of procurement or equivalent test results during current validity period in support of this application (those to ESCC listed first)

Project Name	Testing Level	LAT	Date code	Quantity Delivered
Confidential				

PID changes since start of qualification None <input type="checkbox"/> Minor* <input checked="" type="checkbox"/> Major* <input type="checkbox"/> *Provide details in box: See Annex 2 / Confidential	Current PID Verified by: Burak Gökgöz, German Space Agency at DLR Name of Executive Representative Generic PID: A63500-GEPID-P000, Issue 2h, 20.09.2023 BASxx Detail PID: A63500-D329-P000, Issue 4, 13.10.2021 BXYxx Detail PID: A63500-D336-P000, Issue 4, 13.10.2021
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Current Manufacturing facilities surveyed by: Burak Gökgöz, German Space Agency at DLR on 19-20/09/2023 (Name of Executive Representative) (Date)	Satisfactory: Yes <input checked="" type="checkbox"/> No <input type="checkbox"/> Explain	Report Reference: INFINEON-AUD-DLR-09-2023
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Executive Member: German Space Agency at DLR Date: 19/10/2023

Page 2

Appl. No.

227K

Failure Analysis, DPA, NCCS available: Yes  No  (Supply data)

12

Ref. No's and purposes:

The undersigned hereby certifies on behalf of the ESCC Executive - that the above information is correct; - that the appropriate documentation has been evaluated; - that full compliance to all ESCC requirements is evidence (except as stated in box 15;) - that the reports and data are available at the ESCC Executive and therefore applies on behalf of DLR as the responsible Executive Member for ESCC qualification status to be extended to the component(s) listed herein.

13

Burak  
Goekgoez

Digital signiert von Burak Goekgoez  
DN: C=DE, S=Nordrhein-Westfalen  
, L=Koeln, O=Deutsches Zentrum  
fuer Luft- und Raumfahrt e.V. (DLR)  
, SN=Goekgoez, G=Burak, CN=  
Burak Goekgoez  
Grund: Ich bin der Verfasser dieses  
Dokuments  
Ort: Bonn  
Datum: 2023.11.06 13:49:12+01'00'  
Foxit PDF Editor Version: 13.0.0

Date: 06/11/2023

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Burak Gökgöz, German Space Agency at DLR  
(Signature of the Executive Coordinator)

Continuation of Boxes above:

14



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Page 3

Appl. No.

227K

Non compliance to ESCC requirements:

15

No.:	Specification	Paragraph	Non compliance

Additional tasks required to achieve full compliance for ESCC qualification or rationale for acceptability of noncompliance:

16

Executive Manager Disposition

17

Application Approval: Yes  No

Action / Remarks:

Date:

B. Schade: Head of ESA Product Assurance and Safety Department



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Executive Member: German Space Agency at DLR

Date: 19/10/2023

Page 4

Appl. No.

227K

ANNEX 1: LIST OF TESTS DONE TO SUPPORT EXTENSION OF QUALIFICATION

18

Tests conducted in compliance with:

- ESCC 5010 generic specification; Chart F4A (for ESCC/QPL parts)

Tests vehicle identification/description:

2236LR40, 2229A	BAS70-T1(ES), EnvMechSG, AssCapSG, DecapSG
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Detail Specification reference: 5513/020

Chart F4A	Test	Tick when done	Conditions	Date Code	Tested Qty	No. of Rejects	Comments if not performed. Comments on Rejection
Environmental/Mechanical Subgroups	Thermal Shock Test	<input checked="" type="checkbox"/>	ESCC 5010 Para. 9.5.2	2229A	6	0	
	Shock Test	<input type="checkbox"/>	MIL-STD-750 Test Method 2016				n.a. acc. Detail Spec
	Vibration Test	<input type="checkbox"/>	MIL-STD-750 Test Method 2056				n.a. acc. Detail Spec
	Constant Acceleration	<input type="checkbox"/>	MIL-STD-750 Test Method 2006				n.a. acc. Detail Spec
	Seal Test	<input type="checkbox"/>	MIL-STD-750 Test Method 1071				n.a. acc. Detail Spec
	Moisture Resistance	<input checked="" type="checkbox"/>	MIL-STD-750 Test Method 1021	2229A	6	0	
	Seal Test	<input checked="" type="checkbox"/>	MIL-STD-750 Test Method 1071	2229A	6	0	
	Electrical Measurements at Room Temp.	<input checked="" type="checkbox"/>	Table 2 of the Detail Specification	2229A	6	0	
	External Visual Inspection	<input checked="" type="checkbox"/>	ESCC Basic Specification No. 20500	2229A	6	0	
Endurance Subgroup	Operating Life	<input type="checkbox"/>	MIL-STD-750 Test Method 1026				* 2229A: Former data from Wafer available
	Electrical Measurements during Endur. Test	<input type="checkbox"/>	Table 6 of the Detail Specification				* 2229A: Former data from Wafer available
	External Visual Inspection	<input type="checkbox"/>	ESCC Basic Specification No. 20500				* 2229A: Former data from Wafer available
Electrical Subgroup - Assembly Capability Tests	Solderability Test	<input checked="" type="checkbox"/>	MIL-STD-750 Test Method 2026	2229A	3	0	
	Permanence of Marking	<input type="checkbox"/>	ESCC Basic Specification No. 24800				n.a. due to laser marking
	Terminal Strength	<input checked="" type="checkbox"/>	MIL-STD-750 Test Method 2036	2229A	3	0	
De-encapsulation Tests	Internal visual inspection	<input checked="" type="checkbox"/>	ESCC Basic Specification No. 20400	2229A	6	0	
	Bond Strength	<input checked="" type="checkbox"/>	MIL-STD-750 Test Method 2037	2229A	6	0	
	Die Shear	<input checked="" type="checkbox"/>	MIL-STD-750 Test Method 2017	2229A	6	0	

\* Remark DC 2229 mit Endurance Subgroup on former assembly lots: 1410LR10a, lss. 1, April 2014, DC 1334A all successfully passed.





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Page 7

Appl. No.

227K

**NOTES ON THE COMPLETION OF THE APPLICATION FORM FOR ESCC QUALIFICATION EXTENSION APPROVAL**

**ENTRIES**

- Form heading shall indicate: - the title of the component as given in its detail specification or the name of the series, family; - the Executive Member; - the entering date; - the certificate number and its sequential suffix.
- Box 1** shall provide details given in the table; in particular there shall be listed: - the variants or range of variants; - the range of components (the ESCC code is recommended to indicate the values or values range, the tolerance, the voltage, etc); the designation given in the detail specification as 'base on'; - under Test Vehicle enter either an ESCC code or the specific characteristic capable of identifying the component tested (e.g., voltage of coil for a relay); - under component similar enter a cross if relevant.
- Box 2; 3 and 4** As per QPL entry; otherwise, an explanation of the changes must be supplied.
- Box 5** Will show the ESCC Generic and Detail specifications, including issue number and revision letter, current at the time the tests reported were performed. If the specifications are different from those current on the date of the application, see Box 6.
- Box 6** Will show the deviations from the Generic and Detail Specifications listed in Box 5, in particular deviations from testing. In case of deviations this must be listed in Box 15. In case the referenced specification in Box 5 have currently a different issue and/or revision indicate also whether the test data deviates or not from such current documents.
- Box 7** Must reference the report(s) supplied in support of the application.
- Box 8** Should provide the details of procurement to the full ESCC System, documentation of all of which should already have been delivered to the ESCC Executive under the terms of the relevant Generic Specification. An appropriate table has been drawn in this box.
- Box 9** If the PID evolved after the Original Qualification or after the last Extension of Qualification, adequate details of such evolution shall be provided together with the reasons for the changes. Major changes shall be clearly marked.
- Box 10** Identify the current PID issue status, date and actual date of verification. The date of verification of the current PID should be arranged as close as possible to the required date of extension.
- Box 11** This box can be completed only after a physical visit to the plant to confirm that no unexplained changes occurred and that the practices, procedures, material, etc. used in manufacturing the components are as described in the PID. This survey shall be carried out in accordance with the requirements of ESCC Basic Specification No. 20200 and its findings shall be recorded.
- Box 12** Provide details of, or reference to, any Destructive Physical Analysis (DPA) and Failure Analysis reports as well as any Nonconformance(s) (NCCS) occurred during the qualification validity period, stating if established corrective action have produced satisfactory results.
- Box 13** Enter only the name of the Executive Member (i.e., CNES, DLR, ESTEC, etc.) and the signature of the responsible Executive Coordinator.
- Box 14** To be used when there is a need to expand any of the boxes from 1 through 12. Identify box affected and reference the Box 14 in the relevant Box. Box 14 can be broken into 14a, 14b, etc. if several boxes have to be expanded.
- Box 15** Fill in Table as requested.
- Box 16** Any additional action deemed necessary by the Executive Member to bring the submitted data to a standard likely to be accepted by the ESCC Executive should be listed herein or the reason(s) to accept the noncompliance.
- Box 17** All Executive Manager recommendations on the application itself, special conditions or restrictions, modifications of the QPL or QML entry, letters to the manufacturer, etc. shall be entered clearly in Box 19, signed by the representative for ESA, and dated.
- Box 18** Fill in Table as requested.
- Box 19** Confidential Details of PID changes including those of a confidential nature, shall be provided.
- Box 20** State noncompliance with reference to specification(s) and paragraph(s). To simplify reference in Box 16 each nonconformance shall be sequentially numbered. If relevant state 'None'.
- Box 21** Any additional action deemed necessary by the Executive Member to bring the submitted data to a standard likely to be accepted by the ESCC Executive should be listed herein or the reason(s) to accept the noncompliance.
- Box 22** Additional Comments.